

CMOS Digital Integrated Circuits Silicon Monolithic

TC74ACT240P,TC74ACT244P

1. Functional Description

Octal Bus Buffer
 TC74ACT240P: INVERTED, 3-STATE OUTPUTS
 TC74ACT244P: NON-INVERTED, 3-STATE OUTPUTS

2. General

The TC74ACT240P and TC74ACT244P are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate and double-layer metal wiring C²MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The TC74ACT240P is an inverting 3-state buffer while the TC74ACT244P is non-inverting. Both devices have two active-low output enables.

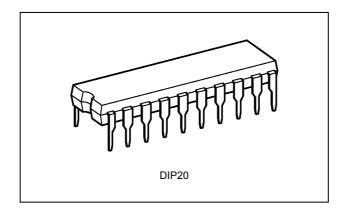
These devices are designed to be used in such applications as 3-state memory address drivers.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

3. Features

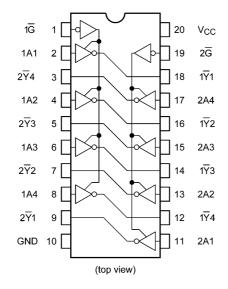
- (1) High speed: Propagation delay time = 5.0 ns (typ.) at V_{CC} = 5.0 V
- (2) Low power dissipation: I_{CC} = 8.0 μ A (max) at T_a = 25 °C
- (3) Compatible with TTL outputs: $V_{IL} = 0.8 V (max)$
 - V_{IH} = 2.0 V (min)
- (4) Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA} (\text{min}) (V_{CC} = 4.5 \text{ V})$
- (5) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (6) Pin and function compatible with 74F240/244.

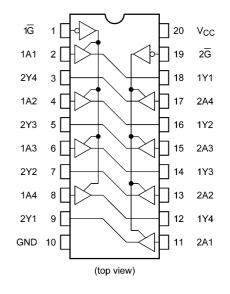
4. Packaging



5. Pin Assignment

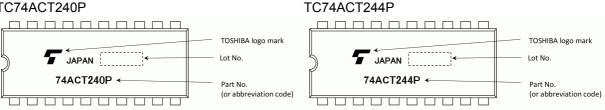
TC74ACT240P





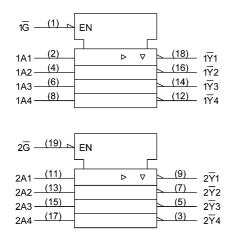
6. Marking

TC74ACT240P



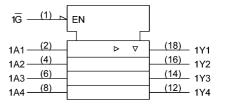
7. IEC Logic Symbol

TC74ACT240P



TC74ACT244P

TC74ACT244P



2G <u>(19)</u>	EN		لے		
2A1 (11) 2A2 (13) 2A3 (15) 2A4 (17)		Δ		(9) (7) (5) (3)	· 2Y1 · 2Y2 · 2Y3 · 2Y4

8. Truth Table

Input G	Input An	Output Yn (TC74ACT244P)	Output Yn (TC74ACT240P)
L	L	L	Н
L	Н	Н	L
Н	Х	Z	Z

X: Don't care

Z: High impedance

9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		±20	mA
Output diode current	I _{ОК}		±50	mA
Output current	I _{OUT}		±50	mA
V _{CC} /ground current	I _{CC}		±200	mA
Power dissipation	PD	(Note 1)	500	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 500 mW in the range of $T_a = -40$ to 65 °C. From $T_a = 65$ to 85 °C a derating factor of -10 mW/°C shall be applied until 300 mW.

10. Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	4.5 to 5.5	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	V
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall times	dt/dv	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	—		4.5 to 5.5	2.0	_	—	V
Low-level input voltage	V _{IL}	—		4.5 to 5.5	_	—	0.8	V
High-level output voltage	V _{OH}	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I _{OH} = -50 μA	4.5	4.4	4.5	—	V
			I _{OH} = -24 mA	4.5	3.94	_	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	4.5	_	0.0	0.1	V
			I _{OL} = 24 mA	4.5	_	_	0.36	
3-state output OFF-state leakage current	I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND		5.5	_	—	±0.5	μΑ
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		5.5	_		±0.1	μA
Quiescent supply	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	_	8.0	μA
current	I _{CCT}	Per input: V_{IN} = 3.4 V Other input: V_{CC} or GND		5.5	_	—	1.35	mA

11.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition		Note	V _{CC} (V)	Min	Max	Unit
High-level input voltage	VIH	—			4.5 to 5.5	2.0	_	V
Low-level input voltage	VIL	—			4.5 to 5.5	_	0.8	V
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA		4.5	4.4		V
			I _{OH} = -24 mA		4.5	3.80	_	
			I _{OH} = -75 mA	(Note 1)	5.5	3.85	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA		4.5	_	0.1	V
			I _{OL} = 24 mA		4.5	_	0.44	
			I _{OL} = 75 mA	(Note 1)	5.5	_	1.65	
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or } GND$			5.5	_	±5.0	μΑ
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND			5.5	_	±1.0	μA
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND			5.5	_	80.0	μA
	I _{ССТ}	Per input: V _{IN} = 3.4 V Other input: V _{CC} or GND			5.5	_	1.50	mA

Note 1: This spec indicates the capability of driving 50 Ω transmission lines.

One output should be tested within a 10 ms maximum duration.

11.3. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Part Number	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Propagation delay time		t _{PLH} ,t _{PHL}		C _L = 50 pF R _L = 500 Ω	5.0 ± 0.5	—	5.7	8.0	ns
3-state output enable time		t _{PZL} ,t _{PZH}		C _L = 50 pF R _L = 500 Ω	5.0 ± 0.5	—	6.0	9.0	ns
3-state output disable time		t _{PLZ} ,t _{PHZ}		C _L = 50 pF R _L = 500 Ω	5.0 ± 0.5	_	5.9	8.5	ns
Input capacitance		C _{IN}		—		_	5	10	pF
Output capacitance		C _{OUT}		—		—	10	—	pF
Power dissipation	TC74ACT240P	C _{PD}	(Note 1)	_		_	25	_	pF
capacitance	TC74ACT244P		(Note 1)	—			29		

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$ (per bit)

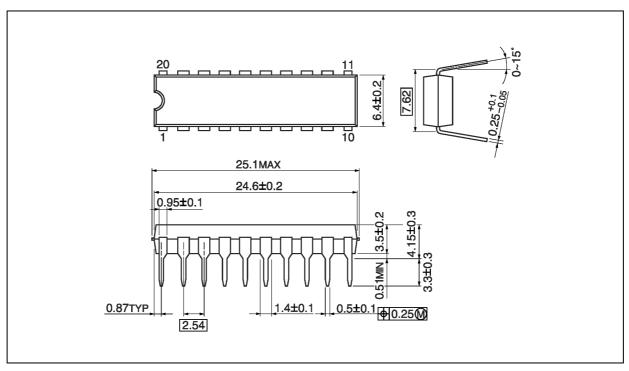
11.4. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	C _L = 50 pF R _L = 500 Ω	5.0 ± 0.5	1.0	9.0	ns
3-state output enable time	t _{PZL} ,t _{PZH}	C _L = 50 pF R _L = 500 Ω	5.0 ± 0.5	1.0	10.5	ns
3-state output disable time	t _{PLZ} ,t _{PHZ}	C _L = 50 pF R _L = 500 Ω	5.0 ± 0.5	1.0	10.0	ns
Input capacitance	C _{IN}	—	-	_	10	pF



Package Dimensions

Unit: mm



Weight: 1.30 g (typ.)

	Package Name(s)
Nickname: DIP20	

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